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Part Number: XDMYK100C

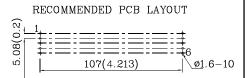
101.2mm (4.0") SINGLE DIGIT NUMERIC DIS-PLAY

Features

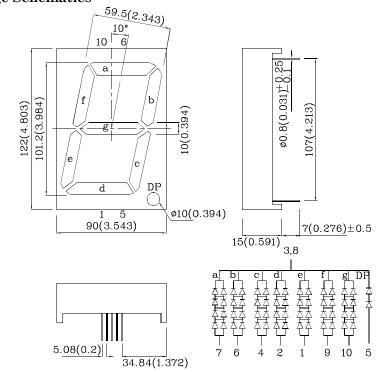
- Low power consumption
- ullet Robust package
- I.C. Compatible
- Standard configuration: Gray face w/ white segments
- Optional black face provides superior color contrast
- RoHS Compliant







Package Schematics



Notes:

- 1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25 (0.01")$ unless otherwise noted.
- 2. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)	MYK (AlGaInP)	Unit		
Reverse Voltage (Per Chip)	V_{R}	5	V	
Forward Current (Dp)	d Current I _F		mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width (Dp)	i_{FS}	350 (175)	mA	
Power Dissipation (Per Chip)	P_{D}	150	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85	-0	
Lead Solder Temperature [2mm Below Package Base]	260°C For 3-5 Seconds			

Operating Characteristics (T _A =25°C)		MYK (AlGaInP)	Unit
Forward Voltage (Typ.) (Dp) (I _F =10mA)	V_{F}	7.8 (3.9)	V
Forward Voltage (Max.) (Dp) (I _F =10mA)	V_{F}	10 (5.0)	V
Reverse Current (Max.) (Per Chip) (V _R =5V)	$I_{ m R}$	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =10mA)	λΡ	590*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) $(I_F=10\text{mA})$	λD	590*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)	$\triangle \lambda$	20	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	20	рF

_	Part Number	Emitting Color	Emitting Material	CIE127 (I _F =10m	-2007*	Wavelength CIE127-2007* nm λP	Description
				min.	typ.		
-	XDMYK100C	Yellow	AlGaInP	150000 52000*	449990 139990*	590*	Common Cathode, Rt.Hand Decimal.

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards. Mar 11,2014

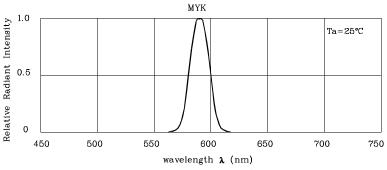
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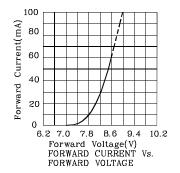
PLAY

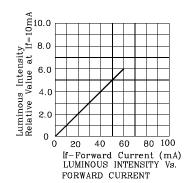


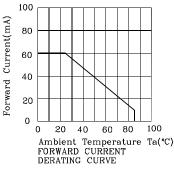


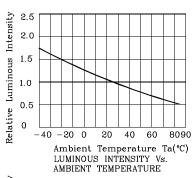
RELATIVE INTENSITY Vs. CIE WAVELENGTH

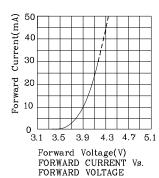
MYK

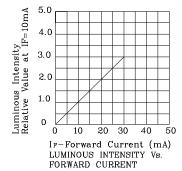


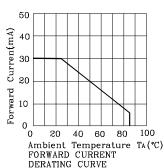


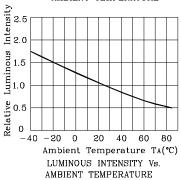




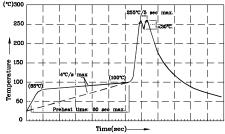








Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



- Notes:

 1. Recommend pre-heat temperature of 105°C or less (as measured thermocouple attached to the LED pins) prior to immersion in the wave with a maximum solder bath temperature of 200°C

 2. Peak wave soldering temperature between 245°C ~ 255°C for 3 smax).
- nax₁.

 3. Do not apply stress to the epoxy resin while the
 4.Fixtures should not incur stress on the componen during soldering process.

 5.SAC 305 solder alloy is recommended.

 6. No more than one wave soldering pass.

- No more than one wave soldering pass.

 During wave soldering, the PCB top-surface temperature should be kept below 105°C.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

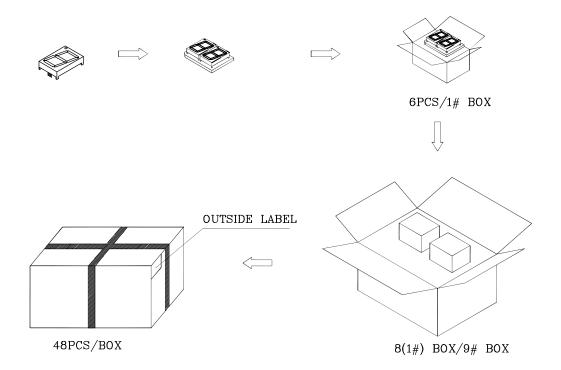
Note: Accuracy may depend on the sorting parameters.

PLAY

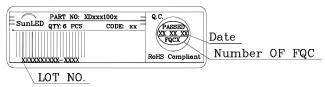


PACKING & LABEL SPECIFICATIONS

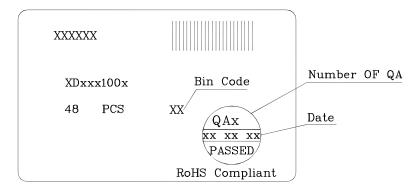
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Inside Label On 1#BOX



Outside Label On Box



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